## PMP5832\_REVA\_SCH BOM

COUNT		Value	Description	Size	Part Number	MFR	AREA
4	C1, C2, C17, C18	3.3uF	Capacitor, Ceramic, 3.3uF, 50V, X7R, 15%	1210	Std	TDK	
1	C10	330uF	Capacitor, Aluminum, SMT, 10V, 20%, 25mOhm	7343(D4)	10TPE330M	Sanyo	62100
2	C11, C28	0.39uF	Capacitor, Ceramic, 16V, X7R, 15%	0805	Std	TDK	
2	C12, C29	56pF	Capacitor, Ceramic, 100pF, 50V, NPO, 5%	0603	Std	Std	
2	C13, C30	1uF	Capacitor, Ceramic, 1-uF, 16-V, X7R, 15%	1206	Std	TDK	15390
2	C14, C31	0.033uF	Capacitor, Ceramic, 0.033uF, 50V, X7R, 15%	0603	Std	TDK	5650
2	C15, C32	0.1uF	Capacitor, Ceramic, 0.1uF, 10V, X7R, 15%	0603	Std	TDK	5650
1	C16	470pF	Capacitor, Ceramic, 220pF, 50V, X7R, 10%	0603	Std	TDK	5650
2	C23, C24	OPEN	Capacitor, Ceramic, 10V, X5R, 15%	0805	Std	TDK	10560
1	C25	22uF	Capacitor, Ceramic, 6.3V, X5R, 20%	0805	Std	Std	10560
2	C26, C27	470uF	Capacitor, Aluminum, SMT, 6.3V, 20%, 25mOhm	7343(D4)	6TPE680M	Sanyo	62100
2	C3, C19	330uF	Capacitor, Alum. 35VDC, ±20%	Code B	EEEFK1V331P	Panasonic	30.90 mm
1	C33	820pF	Capacitor, Ceramic, 220pF, 50V, X7R, 10%	0603	Std	TDK	5650
	C34, C42, C50,						
5	C58, C66	0.1uF	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std	2800
	C35, C43, C51,						
5	C59, C67	22uF	Capacitor, Ceramic, 10V, X5R, 20%	0805	Std	Std	10560
	C36, C44, C52,						
4	C68	33uF	Capacitor, Ceramic, 6.3V, X5R, 20%	1206	STD	STD	15390
	C37, C45, C53,						
5	C61, C69	33uF	Capacitor, Ceramic, 6.3V, X5R, 20%	1206	STD	STD	15390
	C38, C46, C54,						
5	C62, C70	0.1uF	Capacitor, Ceramic, 10V, X5R, 20%	1210	Std	Vishay	28000
1	C39	0.033uF	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std	2800
2	C4, C20	100pF	Capacitor, Ceramic, 100pF, 50V, NPO, 10%	0603	Std	TDK	5650
	C40, C48, C56,						
5	C64, C72	Open	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std	2800
	C41, C49, C57,						
5	C65, C73	15nF	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std	2800
3	C47, C63, C71	0.01uF	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std	2800
1	C4700	1800pF	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std	2800
2	C5, C21	0.18uF	Capacitor, Ceramic, 0.15uF, 25V, X7R, 15%	0805	Std	TDK	
1	C55	0.015uF	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std	2800
2	C6, C22	680pF	Capacitor, Ceramic, 3300pF, 50V, X7R,15%	0603	Std	TDK	5650

1	C60	Open	Capacitor, Ceramic, 6.3V, X5R, 20%	1206	STD	STD	15390
1	C6300	820pF	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std	2800
2	C7, C9	22uF	Capacitor, Ceramic, 10V, X5R, 15%	0805	Std	TDK	10560
1	C8	22uF	Capacitor, Ceramic,10V, X5R, 15%	0805	Std	TDK	10560
3	J1, J2, J3		Terminal Block, 2-pin, 15-A, 5.1mm	0.40 x 0.35""	ED1609	OST	ED1609-ND
	J4, J6, J7, J9, J10,						
	J12, J13, J15, J16,						
12	J18, J19, J20	PEC36SAAN	Header, Male 2-pin, 100mil spacing, (36-pin strip)	0.100 inch x 2	PEC36SAAN	Sullins	
	J5, J8, J11, J14,						
5	J17	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	0.27 x 0.25 inc	r ED555/2DS	OST	70125
2	L1, L2	6.8uH	Inductor, Low Profile High Current, 11A, ±20%	0.51 x 0.52 inc	r IHLP5050EZER6F	R Vishay	342000
5	L3, L4, L5, L6, L7	2.5uH	Inductor, SMT, 4.65A, 8.1milliohm	0.402 x 0.394	ir MSS1038-252	Coilcraft	193,5
4	Q1, Q2, Q4, Q5	FDB8447L	Transistor, NFET, 50A, 40V, 8.5 milliohm	TO-263AB	FDB8447L	Fairchild	312750
2	Q3, Q6	2N7002	MOSFET, N-ch, 60-V, 115-mA, 7.5 Ohms	SOT23	2N7002	Diodes Inc	14105
2	R1, R14	324k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
1	R10	210	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
2	R11, R24	49.9	Resistor, Chip, 49.9 Ohms,1/16-W, 1%	0603	Std	Std	5650
2	R12, R25	10K	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
1	R15	20.5k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
1	R18	140k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
1	R19	26.7k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
1	R2	16.9k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
1	R23	162	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
	R27, R35, R43,						
5	R51, R59	100k	Resistor, Chip, 1/16W, 5%	0402	Std	Std	2800
	R28, R30, R36,						
	R38, R44, R46,						
	R52, R54, R60,						
10	R62	Open	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
	R29, R37, R45,						
5	R53, R61	49.9	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
	R3, R4, R13, R16,						
6	R17, R26	0	Resistor, Chip, 1/10W, 1%	0805	Std	Std	10560
	R31, R39, R47,						
4	R55	10k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
1	R32	1.96k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800

	R33, R41, R49,						
4	R57	182k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
1	R34	37.4k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
3	R40, R48, R56	1.5k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
J 4			· · · · · · · · · · · · · · · · · · ·				
l 4	R42	12.4k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
1	R5	66.5k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
1	R50	22.1k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
1	R58	8.45k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
1	R6	16.2k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
1	R63	20.5k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
1	R64	1.78k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
1	R65	383k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
1	R66	10.2k	Resistor, Chip, 1/16W, 1%	0402	Std	Std	2800
2	R7, R20	200k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
2	R8, R21	0	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
2	R9, R22	100k	Resistor, Chip, 1/16W, 1%	0603	Std	Std	5650
3	TP1, TP5, TP11	5005	Test Point, Red, Thru Hole Compact Style	0.125 x 0.1	25 ir 5005	Keystone	
3	TP2, TP6, TP13	5006	Test Point, Black, Thru Hole Compact Style	0.125 x 0.1	25 ir 5006	Keystone	
	TP20, TP27, TP34,					·	
5	TP41, TP48	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.1	00 ir 5001	Keystone	10
	TP3, TP8, TP9, TP10, TP15, TP16, TP23, TP30, TP37,						
11	TP44, TP51	5002	Test Point, White, Thru Hole Color Keyed	0.100 x 0.1	00 ir 5002	Keystone	10

29	TP49, TP50	5000	Test Point. Red. Thru Hole Color Keved	0.100 x 0.100	) ir 5000	Kevstone	10
29		5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100	ir 5000	Keystone	10
20	TP45, TP46, TP47,	F000	Test Point Red Thru Hele Color Koyed	0.400 v.0.400	) ir 5000	Voyatana	10
	TP40, TP42, TP43,						
	TP36, TP38, TP39,						
	TP32, TP33, TP35,						
	TP28, TP29, TP31,						
	TP24, TP25, TP26,						
	TP19, TP21, TP22,						
	TP14, TP17, TP18,						
	1P4, 1P7, 1P12,						

Notes: 1. These assemblies are ESD sensitive, ESD precautions shall be observed.

- 2. These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- 3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
- 4. Ref designators marked with an asterisk ('\*\*') cannot be substituted.

  All other components can be substituted with equivalent MFG's components.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Audio	www.ti.com/audio	Communications and Telecom	www.ti.com/communications
Amplifiers	amplifier.ti.com	Computers and Peripherals	www.ti.com/computers
Data Converters	dataconverter.ti.com	Consumer Electronics	www.ti.com/consumer-apps
DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
Logic	logic.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com	Wireless	www.ti.com/wireless-apps
RF/IF and ZigBee® Solutions	www.ti.com/lprf		

**TI E2E Community Home Page** 

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2011, Texas Instruments Incorporated

e2e.ti.com